MICROWAVE WPT TECHNOLOGY DEVELOPMENTS FOR SSPS APPLICATION

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1 INTRODUCTION

Japan Space Systems(J-spacesystems, formerly USEF) has been studying Space Solar Power System (SSPS) under a support of Ministry of Economy, Trade and Industry(METI) and the other related agency since 1990s. These studies were ranging from laboratory tests to concept study of SSPS. (Mihara et al., 2009).

In 2008, the Japanese new space policy(the Basic Space Law) was enacted and the Basic Plan for Space Policy was established in 2009. They have selected "5 systems for utilization" and "4 programs od R&D". SSPS is one of the R&D programs. This Plan is a five-year-program, from FY2009 to FY2013, foreseeing the next ten years, describing the basic policy and the measures which the Government should take during this period. (Strategic Headquarters for Space Policy, 2009)

In 2009, METI requested for propals for the Microwave Power Transmission(MPT) ground test(demonstration) according to the Basic Plan, and the proposal of the team of J-spacesystems and companies(Mitsubishi Electric Co. and IHI Aerospace Co.) was adopted. (Fuse et al., 2011)

This is also a joint program between J-spacesystems and the Japan Aerospace Exploration Agency (JAXA). We are planning to conduct a joint MPT ground experiment in fiscal 2014. We will demonstrate the technologies needed to transmit a kW class microwave precisely to the receiving site

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located 50 m from the power transmitting section. In this joint effort, J-spacesystems is in charge of the power transmitting section and the power receiving section, and JAXA is in charge of the Beam Steering Control (BSC) section. (Miyakawa et al., 2011)

2 SSPS REFERENCE MODELS

2.1 Single-bus type Model (FY2002)

Figure 1 illustrates the concept of the tethered-SSPS which is capable of 1.2GW power supply maximum and 0.75GW average on the ground. It is composed of a power generation/transmission panel of 2.0km×1.9km suspended by multi-wires(tethers) deployed from a bus system(single) which is located at 10 km upward. The panel consists of 400 subpanels of 100m×95m with 0.1m thickness. Each subpanel has 9500 power generation/transmission modules of $1m \times 1m$ size. In each power module, the electric power generated by the solar cells is converted to the microwave power and no power line interface exists between the modules. The power module has thin film solar cells both on the upper and lower planes. The microwave transmitting antennas are on the lower plane. The module contains a power processor, microwave circuits, and their controller. Each module transmits a microwave power of 420W maximum. (Sasaki et al., 2006)



Figure 1: Single -bus type SSPS

2.2 Multi-bus type Model (FY2006)

In 2006, the multi-bus type of SSPS was newly proposed. Figure 2 shows the satellite structure of the multi-bus tethered SSPS. The new SSPS system has a multi-module structure. (see Figure 3) In "Unit"SSPS, tethers link the bus system with the power generation/transmission modules. So, a "Unit" SSPS is a small "single-bus type". Each "Unit" itself can transmit power(2.1MW) to Earth. Several "Units" are assembled to "Unit Assemly", and "Unit Assemly" s to "Multi-bus type"SSPS in a similar way.

The concept of this type is, so to speak, "Start Small, Let it Grow". (Yoshioka et al., 2011)



Figure 2: Multi-bus type SSPS



Figure 3: hierarchical structure of power transmitting panels

3 MPT GROUND EXPERIMENT MODEL

3.1 Total System

Figure 4 shows the outline of the MPT Ground Experiment Model, and Figure 5 shows its tree diagram. The model consists of three sections;

- Power Transmitting Section
 - Power Receiving Section

 Beam Steering Control Section (JAXA) As for Beam Steering Control Section, Japan Aerospace Exploration Agency (JAXA) is in charge of the section.



Figure 4: MPT Ground Experiment Model

MPT Ground Experiment Model



Figure 5: Tree Diagram of Ground Experiment Model

To realize SSPS, each section needs to have following features;

for Power Transmitting Section,

- light weight and thin power transmitting modules (transportation and construction cost)
- high efficiency (heat discharge and power generation cost)

for Power Receiving Section,

- electrical robustness (stable operation and maintenance cost)
- high efficiency (power generation cost)
- for Beam Steering Control Section
 - beam steering control accuracy (safety)

To solve these problems, our solutions are; for Power Transmitting Section,

- to develop a thin sub-array
 - to apply highly efficient HPA to GaN HEMT, F-class amplifier
- for Power Receiving Section,
 - to find out the cause of rectenna damage
 - to develop a highly efficient diode
- for Beam Steering Control Section
 - retro directive method (using pilot signal)
 - rotating electromagnetic vector method (REV method)

Beam Steering Control Section has;

- Pilot Signal Transmitting Antenna (Power Receiving Section)
 - Pilot Signal Receiving Antenna
 - (Power Transmitting Section)

The microwave beam frequency is 5.8GHz, and the pilot signal frequency is 2.4GHz band. (Miyakawa et al., 2010)

3.2 Power Transmitting Section

3.2.1 Basic Design

The basic design concept of the power transmitting section is as follows;

- High power (kW-class)
- High efficiency of DC-RF conversion
- Thin phased array (Sub-array)
- Principled reference signal control

Tree diagram of Power Transmitting Section is shown in Figure 6. And the system block diagram of the power transmitting section is shown in Figure 7.





Four power transmitting modules, which are phased array antennas, constitute of the power transmitting section.

A sub-array is the minimum unit. It consists of a BFN, an HPA module(MDL) and four sub-array antennas. A BFN receives microwave, DC power and control signal, and feeds them to the HPA MDL. Each HPA MDL has a phase-shifter, a driver amplifier, a high power amplifier and so on. Then, it provides microwave to four sub-array antennas.

A power transmitting module has 76 Sub-arrays. The module size is 60cm square. One module can output more than 400W. So the power transmitting panel(4 modules) size is about 1.2m square and the output power is about 1.6kW.

Figure 8 shows the outline view of Power Transmitting Section. Pilot Signal receiving antenna is set in the center of each power transmitting module (PT module). It is used for beam steering control.

Each PT module transmits microwave beam to the right direction according to the phase control signal from the beam steering control section. A PT module generates microwave in accordance with the reference signal from RSC master unit. This microwave is amplified by HPA modules (first stage and sub-array) using DC power from the main power supply, and divided by the divider, distributed to the sub-array antennas, and then transmitted.



Figure 7: Block diagram of the power transmitting section



Figure 8: Outline view of power transmitting section.

As for SSPS, relative positions among the power transmitting modules may change. Power Transmitting Section has a function to simulate this situation by moving PT modules manually, for the purpose of verifying the effectiveness of the beam control method under that condition. Table 1 shows the specifications of power transmitting section.

Item	Specification
Microwave	5.8GHz±75MHz
Frequency	
Power	Number: 4
Transmitting	Size: ≈0.6m x 0.6m
Modules	Thickness: ≤40mm (Sub-array)
	Efficiency: $\geq 30\%$ (PT module)
	Mass: ≤19kg (Sub-arrays)
High Power	GaN HEMT with F-class
Amplifier	76 HPAs (per PT module)
(HPA)	Efficiency (PAE): $\geq 60\%$ Ave.
Antenna	0.65λ (33.6±1 mm)
Spacing	
Phase Shifter	5 bit (MMIC)
Transmitting	≥400W (per PT module)
Power	≥1600W (total)

Table 1: Specifications of Power Transmitting Section

As for the following items, our policy is;

- to get low loss Sub-array antenna for high efficiency, rather than for thickness.
- to get thin, light Sub-array structure
- to make a good balance between high efficiency and thickness of HPA module

GaN HEMT with F-class power amplifier is applied to the power transmission section. GaN HEMT has attracted much attention as the state-of-the-art microwave power transistor due to its high voltage and high power density capability. F-class operation was applied for high efficient power amplifier operation. In this work, an internally matched GaN HEMT high efficient amplifier is developed, in which 2nd harmonic at input side and 2nd and 3rd harmonic at outside are tuned with internal matching circuit. Very high Power Added Efficiency(PAE) 70%, with 7W output power was successfully obtained. Figure 9 is the photograph of hermetic sealed metal packaged GaN HEMT high efficienct amplifier. (Yamanaka et al., 2010)



Figure 9: Metal packaged GaN HEMT amplifier

For space application, antenna thickness is very important parameter. Because the huge sized SSPS requires light weight for lower cost transportation and also requires the expansion structure in space.

Figure 10 is the ideal image of thin sub-array structure. Vertical circuit for the connection of the micro wave circuit board to the antenna array substrate was applied for the thickness reduction. The achievement of the thickness was 44.4mm in our early design. We are trying to reduce the thickness with keeping low loss performance. (Namura et al., 2010)



Figure 10: Sub-array radiation part structure image



According to above studies, a new design target is set as Table 2.

Table 2: Design Target (typical)

Item	Specification	Target
Output	≥400W	411W
Power	per PT module	per PT module
Efficiency	≥30%	35%
	as PT Section	as PT Section
Sub-array	≤40mm	34mm
Thickness		
Sub-array	≤19kg	19kg
Mass		

3.2.2 Element Test

In FY2011, a performance verification test of the HPA module(trial product, see Figure 12) was done. It consists of HPA module, Sub-array ANT, BFN etc. It became certain that all test results meet the design target (see Table 3).



Figure 12: HPA module(trial product)

Table 3: HPA	module(trial	product) T	est Result
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Item	Design	Test
	(average)	(average)
Output Power	≥6.1W	6.17W
Efficiency(PAE)	≥40.2%	41.50%
Accuracy of	≤3deg	2.1deg
Phase-Shift	rms	rms
Spurious	\leq - 60dBc	- 65.7dBc
Size	62x62x14.6mm	62x62x14.6mm
Mass	92g	91.3g

We are going to examine the ongoing design of PT module(e.g., performance, size, mass, heat radiation) and make a prototype of sub-array.

3.3 Power Receiving Section

3.3.1 Basic Design

A tree diagram of Power Receiving Section is shown in Figure 13. And the system block diagram of the power receiving section is shown in Figure 14. Power receiving panel consists of 37 power receiving modules. The pilot signal transmitting antenna is set in the center module. (see Figure 15 and Figure 16)



Figure 13: Tree Diagram of Power Receiving Section



Figure 14: Block diagram of the Power Receiving Section

Table 4 shows the specifications of power receiving section. The diodes used in the power receiving module are "regular type"(commercialized product).

The RF-DC efficiency(antenna to rectenna control unit) is estimated by efficiencies of :

- antenna polarization
- rectifying circuit
- rectenna control unit.

As a result, the RF-DC efficiency is estimated to be 56.8%.



Figure 15: Power Receiving Section



Figure 16: Power Receiving Panel (Rectenna Array)



Figure 17: Power Receiving Module

Table 4. Specifications of Power Receiving Section	Table 4: S	specifications	of Power	Receiving	Section
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Item	Specification
Power Receiving	Size : 2.6m × 2.2m
Panel	
Power Receiving	Number: 37
Module	Size: 0.37m x 0.32m
Diode type	Schottky barrier diode
RF-DC	\geq 50% (Regular type, Power
Efficiency	Receiving Panel)
	\geq 80% (Advanced type,
	Rectenna Element)
Receiving Power	\geq 300W (estimated)

3.3.2 Element Test

Figure 18 is the typical block diagram of a rectenna. Self-bias rectifying circuit is used in a rectenna. This circuit has input filter, rectifying diode and output filter. Most of the power loss will be caused by the loss in rectifying diode. There have been several reports on the causes of the loss in diode. (McSpadden et al., 1998)

In parallel to designing power receiving module, we are trying to develop a high efficient Schottky barrier diode for rectifier using GaN material (Advansed type). In this development, an experimental evaluation of the manufacturing process and the manufacturing condition have been done. (Ozawa et al., 2010)

We are considering improvement of efficiency with studying parameters as follows:

- Cj₀: junction capacitance(zero bias)
- Rs: series resistance
- Vbi: built-in voltage
- Vbr: breakdown voltage



Figure 18: block diagram of a rectenna

A trial modelshows more efficiency than that of existing "Regular type". We continue making an effort to improve "Advansed type" diode.

4 MPT GROUND TESTS

We are planning the indoor and outdoor MPT tests. They wil be completed by fiscal 2014.

4.1 Indoor Test

Outline of the indoor(laboratory) test is shown in Table 5.

Facility	anechoic chamber
Test Equipment	Power Transmitting
	Module \times 4
Power Transmitting	≥10 meters
Distance	
Beam Pointing	≤0.5 degrees (rms)
Accuracy	
Microwave Frequency	5.8GHz±75MHz
Pilot Signal Frequency	2.4GHz band
	(Miyakawa et al.,2011)

Table 5: Outline of the indoor test

4.2 Outdoor Test

Outline of the outdoor(field) test is shown in Table 6.

Facility	outdoor field
Test Equipment	MPT Ground
	Experiment Model
	(Power Transmitting
	Module \times 4)
Power Transmitting	≈ 50 meters
Distance	
Transmitting Power	$\approx 1.6 \text{kW} (411 \text{W} \times 4)$
Power Flux Density	315W/m2±20%
@center, 50m	(estimated)
Output Power	≈ 0.3 kW (estimated)

Table 6: Outline of the outdoor test

The objectives of the field test, or the demonstration, are;

- to transmit kW-class power
- to prove precise beam pointing accuracy(retro-directive, REV method)
- to demonstrate WPT (e.g., to feed electricity from rectenna to home electrical appliances

The energy electricity flux density at the receiving position center is calculated in Figure 19.



Figure 19: Electricity flux density

An energy distribution at 50m point is analyzed as shown in Figure 20. The black flame in the figure is shape of the receiving panel.





Figure 21 shows a WPT demonstration image. Layout of power transmitting/receiving sections is to be determined, avoiding any radio wave interference.



Figure 21: WPT Demonstration Image

CONCLUSION

Microwave Ground WPT project is currently going on. Basic design and element tests are in progress. We are planning to conduct the MPT ground experiment in FY 2014 in collaboration with JAXA. We have started to develop a concrete plan for the demonstration. And we should always be conscious that this ground demonstration is a preliminary step toward the next step of demonstration in space.

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